

**Part Number :** <u>1712242015</u>

**Product Description:** zSFP+ Stacked Ganged

Assembly with Metal Spring Fingers, 2-by-2 with 3 Light

Pipes, 80 Circuits

Series Number: 171224

**Status**: Active

**Product Category:** High-Speed I/O Connectors



#### **Documents & Resources**

## **Drawings**

1712242015 sd.pdf

# **3D Models and Design Files**

STEP AP242

**SOLIDWORKS** 

Creo

EE-170071-0001-001.pdf

<u>SP-170426-1000-001.zip</u>

### **Specifications**

AS-170071-0002-001.pdf

PS-170071-0001-001.pdf

TS-170071-0001-001.pdf

# **Product Environment Compliance**

## Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	⊚ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)

Compliant per EU 2015/863	Comp	liant per	EU 201	5/863
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#### **EU RoHS**

## **Compliance Statements**

- EU RoHS
- REACH SVHC
- Low-Halogen

# **Industry Documents**

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### **Substances of Interest**

PFAS

# **EU RoHS Certificate of Compliance**

# Additional Product Compliance Information

#### **Part Details**

#### General

Status	Active
Category	High-Speed I/O Connectors
Series	171224
Description	zSFP+ Stacked Ganged Assembly with Metal Spring Fingers, 2-by-2 with 3 Light Pipes, 80 Circuits
Application	Module-to-Board
Component Type	Receptacle
Product Name	zSFP Plus,zSFP+
Туре	Pluggable
UPC	887191132907

## Agency

UL E29179
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#### **Electrical**

Current - Maximum per Contact	0.5A
Data Rate	28.0 Gbps

Shielded	Yes
Shield Type	EMI Fingers
Voltage - Maximum	30V AC (RMS)/DC

# Physical

Circuits (Loaded)	80	
Color - Resin	Black	
Durability (mating cycles max)	100	
Flammability	94V-0	
Gender	Female	
Lock to Mating Part	Yes	
Material - Metal	High Performance Alloy (HPA)	
Material - Plating Mating	Gold	
Material - Plating Termination	Matte Tin	
Material - Resin	High Temperature Thermoplastic	
Net Weight	51.152/g	
Number of Rows	2	
Orientation	Right Angle	
Packaging Type	Tray	
Panel Mount	No	
PCB Locator	Yes	
PCB Retention	Yes	
PCB Thickness - Recommended	1.57mm	
Pitch - Mating Interface	0.80mm	
Pitch - Termination Interface	0.80mm	
Plating min - Mating	0.762µm	
Plating min - Termination	0.762µm	
Polarized to Mating Part	Yes	
Polarized to PCB	Yes	
Ports	4	
Temperature Range - Operating	-40° to +85°C	
Termination Interface Style	Through Hole - Compliant Pin	